



SURFACE MOUNT GLASS PASSIVATED SILICON RECTIFIER **VOLTAGE 1200 Volts CURRENT 3.0 Amperes**

FEATURES

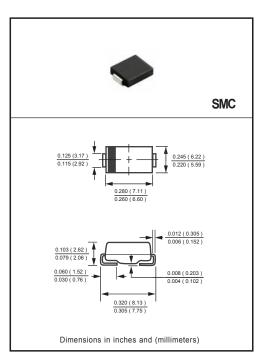
- * Glass passivated device
- * Ideal for surface mounted applications
- * Low leakage current
- * Metallurgically bonded construction
- * Mounting position: Any
- * Weight: 0.24 gram

MECHANICAL DATA

- * Epoxy : Device has UL flammability classification 94V-0
- * MSL: 1 Level

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified. resistive or inductive load.



MAXIMUM RATINGS (@ TA=25 °C unless otherwise noted)

RATINGS RATINGS	SYMBOL	FM3012-W-A01	UNITS
Maximum Recurrent Peak Reverse Voltage		1200	Volts
Maximum RMS Voltage	V _{RMS}	840	Volts
Maximum DC Blocking Voltage	V _{DC}	1200	Volts
Maximum Average Forward Rectified Current at Ambient Temperature	I _O	3.0	Amps
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	I _{FSM}	100	Amps
Typical Current Squared Time	I ² T	41.5	A ² S
Typical Thermal Resistance (Note 1)	R _{θJA}	47	°C/W
Typical Thermal Resistance (Note 1)	Røjl	13	°C/W
Typical Junction Capacitance (Note 2)	CJ	30	pF
Operating Temperature Range	TJ	150	°C
Storage Temperature Range	T _{STG}	-55 to + 150	۰C

ELECTRICAL CHARACTERISTICS(@TA=25 °C unless otherwise noted)

CHARACTERISTICS		SYMBOL	FM3012-W-A01	UNITS
Maximum Instantaneous Forward Voltage at 3.0A DC		VF	1.1	
Maximum Average Reverse Current	@T _A = 25°C		2.0	μА
at Rated DC Blocking Voltage	@T _A = 100°C	IR	125	цΑ

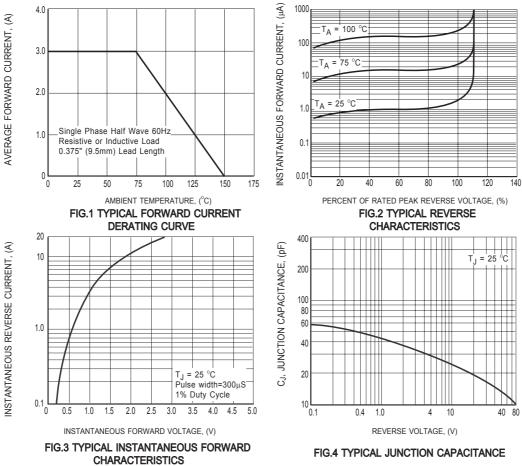
NOTES: 1. Thermal Resistance :Mounted on PCB.

- 2. Measured at 1 MHz and applied reverse voltage of 4.0 volts.
- 3. "Fully ROHS compliant","100% Sn plating (Pb-free)".4. Available in Halogen-free epoxy by adding suffix -HF after the part nbr.

2012-09

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RATING AND CHARACTERISTICS CURVES (FM3012-W-A01)



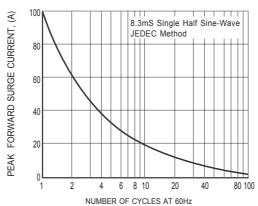
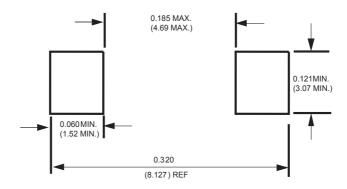


FIG.5 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT



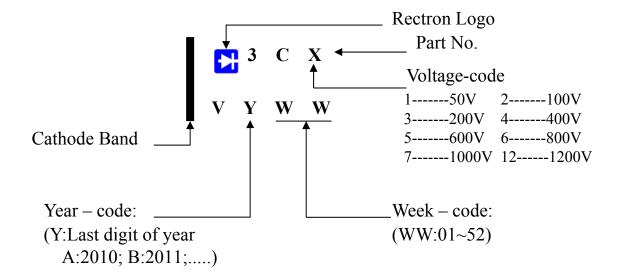
Mounting Pad Layout



Dimensions in inches and (millimeters)



Marking Description





PACKAGING OF DIODE AND BRIDGE RECTIFIERS

REEL PACK

PACKAGE	PACKING CODE	EA PER REEL	COMPONENT SPACE(mm)	TAPE SPACE (mm)	REEL DIA (mm)	CARTON SIZE (mm)	EA PER CARTON	GROSS WEIGHT(Kg)
SMC	-T	500			176	390*205*310	12,000	6.65
SMC	-W	3,000			330	355*360*350	24,000	11.50



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